

### SLOVENSKI STANDARD oSIST prEN 62769-115-2:2018

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Vključitev procesne naprave (FDI) - 115-2. del: Profili - Modbus- RTU

Field device integration (FDI) - Part 115-2: Profiles - Modbus-RTU

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Ta slovenski standard je istoveten z: prEN 62769-115-2:2018

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### 65E/574/CDV

#### COMMITTEE DRAFT FOR VOTE (CDV)

	DATE OF CIRCULATION	ON:	CLOSING DATE FOR VOTING:			
	2017-12-29		2018-03-23			
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	65E/546/NP,65E/570/RVN					
IEC SC 65E : DEVICES AND INTEGRATIO	N IN ENTERPRISE SYS	TEMS				
SECRETARIAT:		SECRETARY:				
United States of America		Mr Donald (Bob) Lattimer				
OF INTEREST TO THE FOLLOWING COMMI	TTEES:	PROPOSED HORIZO	NTAL STANDARD:			
SC 65C						
iTeh S7		Other TC/SCs are requested to indicate their interest, if any, in this CDV to the secretary.				
FUNCTIONS CONCERNED:	tandard	ls.iteh.a	1)			
☐ EMC ☐ ENVIR	RONMENT	QUALITY ASSUR	ANCE SAFETY			
Submitted for CENELEC parallel voting NEC 62 Not submitted for CENELEC parallel voting https://standards.iteh.ai/catalog/standards/sist/e22482e0-e8dd-4a16-91a7-c4dc58047798/sist-en-ec-62769-115-2-2021						
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TITLE:						
FIELD DEVICE INTEGRATION (FDI) – PART 115-2: Profiles – Modbus-RTU						
Note from TC/SC officers:						

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#### INTERNATIONAL ELECTROTECHNICAL COMMISSION 1000 1001 1002 FIELD DEVICE INTEGRATION (FDI) -1003 1004 PART 115-2: Profiles – Modbus-RTU 1005 1006 1007 **FOREWORD** 1008 1009 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising 1010 all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To 1011 1012 this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC 1013 Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested 1014 1015 in the subject dealt with may participate in this preparatory work. International, governmental and non-1016 governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely 1017 with the International Organization for Standardization (ISO) in accordance with conditions determined by 1018 agreement between the two organizations. 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international 1019 1020 consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees. 1021 1022 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC 1023 1024 Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any 1025 misinterpretation by any end user. 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications 1026 1027 transparently to the maximum extent possible in their national and regional publications. Any divergence 1028 between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in 1029 1030 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any 1031 services carried out by independent certification bodies. 1032 1033 6) All users should ensure that they have the latest edition of this publication. 1034 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and 1035 members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and 1036 expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC 1037 1038 Publications. 1039 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is 1040 indispensable for the correct application of this publication. 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of 1041 patent rights. IEC shall not be held responsible for identifying any or all such patent rights. 1042 International Standard IEC 62769-115-2 has been prepared by subcommittee 65E: Devices 1043 and integration in enterprise systems, of IEC technical committee 65: Industrial-process 1044 measurement, control and automation. 1045 This document is based on FCG TS62769-115-2 Profiles PSD ModbusRTU 1.1.0.4, a specification 1046 of the FieldComm Group, PROFIBUS Nutzerorganisation e. V., OPC Foundation and FDT 1047 Group. 1048 The text of this International Standard is based on the following documents: 1049

FDIS Report on voting
65E/XX/FDIS 65E/XX/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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1054 1055	A list of all parts in the IEC 62769 series, published under the general title <i>Field Device Integration (FDI)</i> , can be found on the IEC website.
1056 1057 1058	The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be
1059	• reconfirmed,
1060	withdrawn,
1061	replaced by a revised edition, or
1062	amended.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

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The National Committees are requested to note that for this document the stability date is 2023.

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THIS TEXT IS INCLUDED FOR THE INFORMATION OF THE NATIONAL COMMITTEES AND WILL BE DELETED AT THE PUBLICATION STAGE.

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1070 1071		FIELD DEVICE INTEGRATION (FDI) – Part 115-2: Profiles – Modbus-RTU
1072		
1073	1	Scope
1074 1075 1076	gei	is document defines the protocol-specific definitions (PSDs) as defined in IEC 62769-7 on neric protocol extensions for the Modbus <sup>1</sup> -RTU protocol according to CPF 15 in C 61784-2.
1077	2	Normative References
1078 1079 1080 1081	cor cite	e following documents are referred to in the text in such a way that some or all of their ntent constitutes requirements of this document. For dated references, only the edition ed applies. For undated references, the latest edition of the referenced document (including y amendments) applies.
1082 1083		C 61804 (all parts), Function blocks (FB) for process control and Electronic Device Description aguage (EDDL)
1084 1085		C 61804-3, Function blocks (FB) for process control and Electronic Device Description Language (DL) – Part 3: EDDL syntax and semantics
1086	IE	C 62541-100:–, OPC Unified Architecture – Part 100: OPC UA for Devices
1087	IE	C <b>62769</b> -2, Field Device Integration (FDI) – Part 2: FDI Client
1088	IE	C <b>62769-</b> 4, Field Device Integration (FDI) – Part 4: FDI Packages
1089	IE	C <b>62769-</b> 5, Field Device Integration (FDI) – Part 5: FDI Information Model
1090	IEC	C <b>62769-</b> 7, Field Device Integration (FDI) – Part 7: FDI Communication Devices
1091 1092		C 61784-2, Industrial communication networks — Profiles — Part 2: Additional fieldbus ofiles for real-time networks based on ISO/IEC 8802-3
1093	MC	DD06, Modbus.org: MODBUS over serial line specification and implementation guide V1.02
1094	MC	DD12, Modbus.org: MODBUS APPLICATION PROTOCOL SPECIFICATION, V1.1b3
1095	3	Terms, definitions, abbreviated terms and acronyms
1096	3.1	Terms and definitions
1097 1098		r the purposes of this document, the terms and definitions given in IEC 61784-1, IEC 61804 ries, IEC 62541-100, IEC 62769-4, IEC 62769-5, and IEC 62769-7 apply.
1099 1100		O and IEC maintain terminological databases for use in standardization at the following dresses:
1101	•	IEC Electropedia: available at http://www.electropedia.org/
1102	•	ISO Online browsing platform: available at http://www.iso.org/obp
1103	3.2	Abbreviated terms and acronyms
1104 1105 1106 1107 1108	ED	DL Electronic Device Description Language (see IEC 61804)  Field Device Integration

- 1109 XML Extensible markup language (see REC-xml-20081126)
- 1110 4 Conventions
- 1111 **4.1 EDDL syntax**
- This document specifies content for the EDD component that is part of FDI Communication
- 1113 Packages. The specification content using EDDL syntax uses the font Courier New. The
- 1114 EDDL syntax is used for method signature, variable, data structure and component
- 1115 declarations.
- 1116 4.2 Capitalizations
- 1117 The IEC 62769 series use capitalized terms to emphasize that these terms have a FDI
- 1118 specific meaning.
- Some of these terms using an acronym as a prefix for example
- 1120 FDI Client, or
- 1121 FDI Server.
- Some of these terms are compound terms such as:
- Communication Servers, or
- 1124 Profile Package.
- 1125 Parameter names or attributes are concatenated to a single term, where the original terms
- start in this term with a capital letter such as:
- ProtocolSupportFile or (standards itch ai
- 1128 ProtocolType.
- 1129 Parameter names or attributes can also be constructed by using an underscore character to
- 1130 concatenate two or more terms such as:
- 1131 DEVICE REV or c4dc58047798/sist-en-iec-62769-115-2-202
- 1132 DEVICE MODEL
- 1133 5 PSDs for ModbusRTU
- 1134 **5.1 General**
- 1135 Clause 5 defines the protocol-specific definitions for Modbus-RTU, which is the Modbus over
- serial line protocol using the transmission method RTU (Remote Terminal Unit) according to
- 1137 MOD06.
- 1138 **5.2 Header**
- The HEADER string used to define EDD commands contains the information about what
- Modbus function is called and what is addressed by the function. It shall contain the attribute
- 1141 FUNCTION and may, depending on the FUNCTION, contain the attribute SUBFUNCTION,
- 1142 READ ADDRESS, READ COUNT, WRITE ADDRESS and WRITE COUNT. The syntax is
- 1143 <attribute> = "<value>" per attribute, attributes are separated by a space. The value is
- provided as decimal value, not as hexadecimal value. For example, to read the device
- 1145 identification (function 43 (0x2B) and sub-function 14 (0x0E)) the HEADER string is
- 1146 "FUNCTION=\"43\" SUBFUNCTION=\"14\"".
- 1147 NOTE The character \ is used as escape character allowing " in the HEADER string.
- 1148 The values for READ\_ADDRESS, READ\_COUNT, WRITE\_ADDRESS, WRITE\_COUNT are
- restricted to numeric values between 0 and 65536. Table 1 specifies the allowed Modbus
- 1150 FUNCTION values and the usage of the attributes, as well as the used EDD COMMAND
- 1151 OPERATION.

Table 1 – Modbus Functions and their representation in an EDD HEADER

Functionality	FUNCTION	SUBFUNCTION (Byte)	READ_ADDRESS	READ_COUNT	WRITE_ADDRESS	WRITE_COUNT	Operation (in EDD)a)	Request (in EDD)	Response (in EDD)
Read Coils	01	-	Starting address	Quantity of coils	-	-	R	-	Coil Status
Read Discrete Inputs	02	-	Starting address	Quantity of Inputs	-	-	R	-	Input Status
Read Holding Registers	03	-	Starting address	Quantity of Reg.	-	-	R	-	Reg. Value
Read Input Registers	04		Starting address	Quantity of Input Reg.	-	-	R	-	Input Reg.
Write Single Coil	05	-	-	-	Output addres	-	W	Output Value	Output Value
	-17	70h	STA	NIDAI	S	DDI			r
Write Single Reg.	06	ČII	(sta	ndard	Reg. addres s	eh.a	W	Reg. Value	Reg. Value
Read Exception Status	07	-	SIST	EN IEC 62	<del>-</del> 769-115	-2:2021	R	-	Output Data
Diagnostics	08	2 C	s.iteli.ai/ca 4dc58047	italog/stand 798/sist-en-	arus/sist/ iec-6276	<del>e22482</del> 9-115-2	R, C <sup>b)</sup>	Data	Data
Get Comm Event Counter	11	-	-	-	-	-	R	-	Status + Event Count
Get Comm Event Log	12	-	-	-	-	-	R	-	Status + Event Count + Message Count + Events
Write Multiple Coils	15	-	-	1	Startin g Addre ss	Quan tity of Outp.	W	Outp. Values	-
Write Multiple registers	16	-	-	-	Startin g Addre ss	Quan tity of Reg.	W	Reg. Value	-
Report Server ID	17	-	-	-	-	-	R	-	Server ID + Run Indicator Status + Additional Data
Read File Record	20	-	-	-	-	-	R	Sub- Req	Sub-Req
Write File Record	21	-	-	-	-	-	W	Sub- Req	Sub-Req